



Cite this: RSC Adv., 2017, 7, 4135

## Enhanced $\text{Cl}_2$ sensitivity of cobalt-phthalocyanine film by utilizing a porous nanostructured surface fabricated on glass†

Arvind Kumar,<sup>a</sup> Soumen Samanta,<sup>b</sup> S. Latha,<sup>a</sup> A. K. Debnath,<sup>b</sup> Ajay Singh,<sup>b</sup> K. P. Muthe<sup>b</sup> and Harish C. Barshilia<sup>\*a</sup>

In this paper, we demonstrate a very simple and effective approach to improve the sensitivity and the low detection limit of cobalt phthalocyanine (CoPc) films towards the detection of chlorine by creating a porous nanostructured surface on a glass substrate *via* a vapor phase etching process. CoPc films grown on etched glass (CoPc-etched films) exhibited entirely different morphology as compared to CoPc films grown on plain glass (CoPc-plain films). For 60 nm thickness, randomly distributed CoPc nanostructures were grown on the etched surface, whereas the CoPc-plain film showed an elongated granular structure. For 250 ppb  $\text{Cl}_2$  exposure, the CoPc-etched film showed a response of ~105%, which is ~5 times higher than the CoPc-plain film (20%). In addition, it can detect  $\text{Cl}_2$  down to 100 ppb concentration; this low detection limit is superior to CoPc-plain film (250 ppb). The improved gas sensing property of CoPc-etched film is ascribed to the presence of more interaction sites for gas adsorption, which is confirmed by charge transport, X-ray photoelectron spectroscopy and Kelvin probe measurement. This novel approach of improving the sensitivity and low detection limit paves a new way for the application of surface etching in the gas sensing field of organic semiconductors.

Received 13th October 2016  
 Accepted 4th December 2016

DOI: 10.1039/c6ra25185d  
[www.rsc.org/advances](http://www.rsc.org/advances)

### 1. Introduction

Chlorine ( $\text{Cl}_2$ ) gas is greenish-yellow in color and is extensively used in many areas such as purification of water supplies, paper and textile mills as a bleaching agent, household cleaning items, pharmaceutical and chemical industries *etc.*<sup>1–3</sup> It is extremely poisonous to humans as well as animals. The toxic limit of  $\text{Cl}_2$  is 0.5 parts-per-million (ppm), and a few deep breaths with an average exposure of a few ppm can lead to a lethal situation for humans.<sup>1,2,4</sup> Therefore, improving the capability of  $\text{Cl}_2$  sensors to monitor  $\text{Cl}_2$  at the parts-per-billion (ppb) level with high sensitivity is highly desirable for the safe utilization of this toxic gas. Among the organic semiconductors, gas sensing properties of metal-phthalocyanine (MPcs) have been comprehensively studied owing to their high thermal stability (up to 400 °C), semiconducting properties, exceptional barrier properties against strong acids and bases, tunability of chemical and physical properties, *etc.*<sup>5–12</sup> MPcs show many

advantages over metal oxides and other inorganic materials such as high sensitivity, fast response, low operating temperature and ability to detect the toxic gas down to ppb level.<sup>11,13,14</sup> In the last few years, many efforts have been devoted to improve the sensitivity as well as low detection limit of the phthalocyanine based gas sensors. For instance, Miyata *et al.* investigated that CuPc and MgPc based gas sensors can detect  $\text{Cl}_2$  down to 180 ppb concentration, and it has been shown that the sensitivity could be maximized by optimizing the film thickness and operating temperature.<sup>5,15</sup> Tingping *et al.* fabricated the  $\text{Cl}_2$  gas sensor using PANI/ZnPcCl<sub>2</sub> based hybrid films, and hybrid sensor exhibited superior gas sensing characteristic over ZnPcCl<sub>2</sub>.<sup>16</sup> Soumen *et al.* showed that sensitivity of MPcs film could be improved significantly using the appropriate substrate. CoPc films deposited on sapphire substrate exhibited enhanced sensitivity as compared to the CoPc film grown glass substrate under similar conditions.<sup>11</sup> Kumar *et al.* reported the enhanced  $\text{Cl}_2$  sensitivity of bi-nuclear PCs films over mono-nuclear Pcs films due to the improved charge carrier mobility.<sup>17</sup> It has also been demonstrated that the Au doped CoPc films showed superior  $\text{H}_2\text{S}$  gas sensing properties over un-doped CoPc film due to the high density of holes carriers in doped CoPc.<sup>18</sup> It is well known that nanostructured surfaces have large surface/volume ratio, hence nanostructured based thin film of sensing materials exhibit superior gas sensing characteristics compared to smooth films due to the presence of large number

<sup>a</sup>Nanomaterials Research Laboratory, Surface Engineering Division, CSIR – National Aerospace Laboratories, Bangalore-560017, India. E-mail: harish@nal.res.in; Fax: +91-80-2521-0113; Tel: +91-80-2508-6248

<sup>b</sup>Thin Film Devices Section, Technical Physics Division, Bhabha Atomic Research Centre, Mumbai-400085, India

† Electronic supplementary information (ESI) available. See DOI: 10.1039/c6ra25185d



of active gas-material interaction sites. Recently, phthalocyanine based nanowires, nano-flowers and nanobelts have been fabricated, and these nanostructured thin films showed a high  $\text{Cl}_2$  sensitivity with minimum detection limit down to 5 ppb.<sup>2,13</sup>

Furthermore, new types of phthalocyanines have also been synthesized for gas sensing application. For example, Altindal *et al.* have investigated the halogen ( $\text{Cl}_2$  and  $\text{Br}_2$ ) gas sensing properties of crosswise substituted phthalocyanines as a function gas concentration (5–150 ppb) at different substrate temperatures (5–75 °C) by measuring both ac and dc conductivity.<sup>19</sup> Kaki *et al.* have synthesized new ball-type homodinuclear and heterodinuclear phthalocyanine and their vapor sensing properties as function of temperature and vapor concentration have been studied.<sup>12</sup> In addition, various kinds of MPcs based hybrid structures such as polypyrrole/phthalocyanine, TFPMPCs/MWCNT, CoPc functionalized by carbon nanotube *etc.*, have also been employed in gas the sensing applications.<sup>20–23</sup> In addition, several other materials used for the detection of  $\text{Cl}_2$  have been summarized in Table 1.<sup>24–33</sup> The sensitivity and operating temperature of these sensors have also been shown.

Gas sensing is a surface phenomenon, therefore, the morphology of the sensing material greatly influences its sensing properties. It is well established that substrate's surface plays a pivotal role to tune the morphology of the deposited materials. It is believed that if the layer of any sensing material is deposited on nanostructured surface, it may have more interaction sites for gas adsorption. Hence, with this approach it may be possible to improve the sensitivity of the MPcs films just by creating the appropriate nanostructures on the substrate. To the best of our knowledge the utilization of nanostructured surfaces has not been explored to tune the morphology of organic semiconductors for improving their gas sensing characteristics.

In this paper, for the first time we demonstrate that the sensitivity of the CoPc film can be enhanced by introducing a porous nanostructured surface on glass substrate *via* vapor phase etching process. CoPc film grown on etched surface shows a significant enhancement in  $\text{Cl}_2$  sensitivity along

with improved low detection limit as compared to CoPc film grown plain glass. Moreover, we have shown that CoPc films are highly selective and exhibited good repeatability as well.

## 2. Experimental details

A porous nanostructure surface was fabricated on the half portion of glass substrate using HF-vapor phase etching method with substrate of 50 °C. The details about the vapor phase etching process can be found elsewhere.<sup>34</sup> Before depositing the CoPc film, glass substrates were ultrasonically cleaned in the trichloroethylene, acetone and methanol. After that they were dried using the stream of dry argon jet. CoPc films (20 and 60 nm) were deposited using vacuum evaporation on plain and etched glass substrates under a base vacuum of  $\sim 2.0 \times 10^{-6}$  Torr. The substrate temperature and deposition rate were kept  $\sim 200$  °C and 2 Å s<sup>-1</sup>, respectively. To study the *J-V* and gas sensing characteristics of CoPc films, an electrical contact was made using two planer gold electrodes of size 2 mm × 2 mm separated by 12 µm. The thickness of the gold electrodes was kept  $\sim 100$  nm. The schematic details of the substrate treatment, CoPc film deposition and Au-electrode fabrication for *J-V* as well as gas sensing measurements are depicted in Fig. 1. The change in conductance of CoPc film with time (response curves) was recorded in the presence of test gas using a static gas testing setup. CoPc thin film sensors were fixed on the heater mounted in a closed stainless steel chamber of net volume 983 cm<sup>3</sup>. In order to achieve the desired ppm level of the target gas inside the chamber, a measured quantity of gas was injected using a micro-syringe and recovery of CoPc sensors was obtained by exposing them to ambient air. The conductance with time and *J-V* characteristics of CoPc films were measured by Keithley 6487 voltage source/picoammeter system using Labview software. The response (*R*) of the sensor has been calculated by the relative change in the conductance (or electric current) of the sensor using the following equation:<sup>2,11</sup>

$$R = \frac{(C_t - C_0)}{C_0} \times 100 = \frac{(I_s - I_0)}{I_0} \times 100 \quad (1)$$

where,  $C_t$  and  $I_t$  denote conductance and generated electric current at any time, while,  $C_0$  and  $I_0$  are base conductance and base current of the CoPc films, respectively.

The surface roughness and morphology of CoPc films deposited on plain and etched substrate were examined using atomic force microscopy (AFM, Bruker, Nano) and field emission scanning electron microscopy (FESEM, Carl Zeiss, SUPRA 40VP), respectively. The X-ray photoelectron spectroscopy (XPS, DESA-150 Electron Analyzer, Staib Instruments, Germany) of the CoPc films was carried out using Mg K $\alpha$  with base vacuum of  $2 \times 10^{-9}$  Torr and the XPS binding energy scale was calibrated using C-1s line at 284.8 eV. The work function of CoPc films was measured by Kelvin Probe technique (SKP 5050, KP Technology Ltd. UK) with gold tip having diameter 2 mm (2 meV resolution). Before measurements, the gold tip work function was calibrated using a standard gold/aluminum sample provided by KP technology. The thickness of CoPc film was measured by 3D profilometer (NanoMap 500 LS AEP Tech.).

Table 1 Different materials used for chlorine detection

Materials used	Operating temperature (°C)	Detection limit (in ppm)	Ref.
$\text{In}_2\text{O}_3$	450	0.2	24 and 25
$\text{In}_2\text{O}_3\text{-Fe}_2\text{O}_3$	400	0.1	26
$\text{ZnO}$	300	300	25 and 27
$\text{ZnO-CuO}$	50	300	27
$\text{SnO}_2$ doped with Sb	RT	3	25
$\text{WO}_3/\text{FeNbO}_4$	230	1	28
$(\text{NiFe}_2\text{O}_4)$	180	1000	29
Bisporphyrin	170	0.01	30
Pd doped $\text{NiFe}_2\text{O}_4$	325	1	31
$\text{ZnO NW-PPy}$	RT	1	32
$\text{CuPcOC}_6\text{-MWCNTs}$	RT	100	33



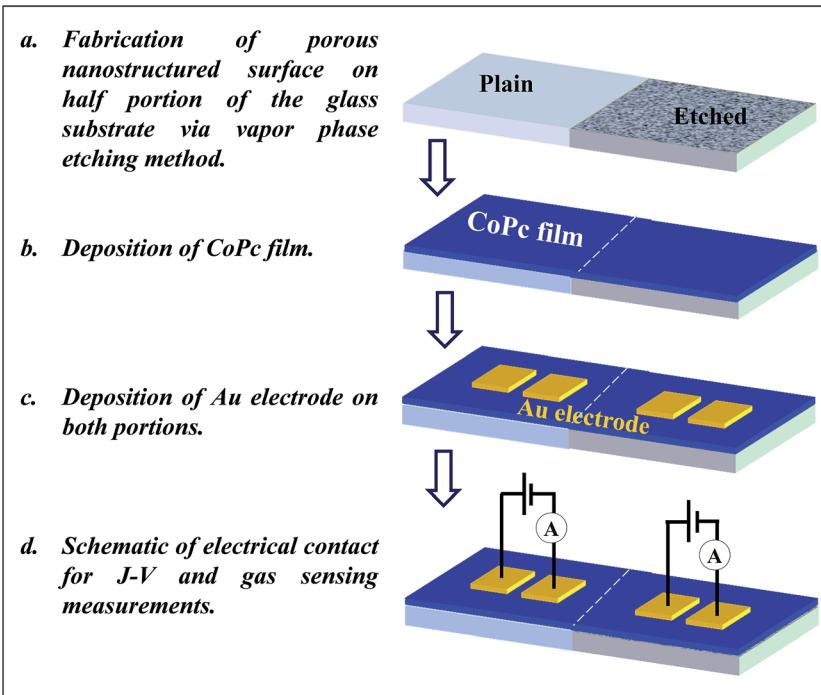


Fig. 1 Schematic representing the steps of porous nanostructured surface formation, CoPc film and Au electrode deposition and electrical circuit for  $J$ – $V$  and sensing experiments.

### 3. Results and discussion

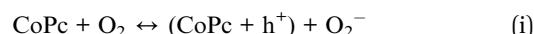
#### 3.1. Morphological studies

Fig. 2(a) and (b) show the surface morphology of glass substrates before and after etching, respectively. The FESEM image of plain glass exhibits that the surface is very smooth and feature less with  $\sigma_{\text{rms}} = 3$  nm, whereas the etched surface consists of randomly distributed nanopores of different sizes as shown in Fig. 2(b). In addition, the value of  $\sigma_{\text{rms}}$  is increased to  $\sim 7$  nm, which is attributed to the formation of porous nanostructured surface on the etched glass. It is believed that CoPc films grown on porous nanostructured surface provide the large surface area for gas adsorption as compared to the CoPc films grown on plain glass. In order to examine the effect of nanoporous surface on film morphology, CoPc films of thickness 20 and 60 nm were grown on plain and etched surface under similar conditions. The FESEM images of these films are presented in Fig. 2(c)–(f). CoPc film of 20 nm grown on plain glass shows granular morphology, and  $\sigma_{\text{rms}}$  was found to be  $\sim 7$  nm. At 60 nm, CoPc grains get elongated, and few places the growth of nanostructured islands can also be seen. In addition, the  $\sigma_{\text{rms}}$  increased to  $\sim 14$  nm (Fig. 2(e)). On the other CoPc films grown on etched surface shows entirely different morphology. FESEM image of CoPc film of 20 nm shown in Fig. 2(d), reveals that films consists of CoPc nanostructured growing in vertical direction, and the  $\sigma_{\text{rms}}$  was found to be  $\sim 13$  nm. With increasing the thickness to 60 nm, these nanostructures grow in size and occupy the all space with  $\sigma_{\text{rms}} = 21$  nm as depicted in Fig. 2(f). The role of etched surface during the CoPc film growth is not clear so far and it is under investigated. However, it is believed that nanopores on the etched surface acts

as nucleation centers and helps to promote the CoPc nanostructured growth with faster rate. For 60 nm thickness, CoPc films grown on etched surface show fully grown nanostructured surface as compared to CoPc film deposited on plain surface, which is expected to have relatively large numbers of adsorption sites. Therefore, electrical and gas sensing properties of these two CoPc films of thickness 60 nm were further studied. The thickness of CoPc film deposited on glass was further confirmed by 3D profilometer (shown in Fig. 3(a)). The distinguishable step formed between the glass substrate and CoPc film allows the determination of the film thickness. The estimated thickness of CoPc film was found to be  $\sim 63$  nm. Moreover, in order to investigate the purity and elemental uniformity, CoPc film has been characterized by various spectroscopy techniques. Further details can be found in the ESI S1 and S2.† In the latter part of this paper, CoPc films grown on plain and etched surface will be termed as CoPc-plain and CoPc-etched film, respectively.

#### 3.2. Electrical and gas sensing properties

Now we discuss the electrical properties of CoPc-plain and CoPc-etched films. Intrinsically, CoPc film behaves as an insulator but when it exposed to the atmosphere it becomes semiconductor, which is attributed to the chemisorption of ambient oxygen.<sup>9,11</sup> The chemisorbed oxygen induces the hole carriers in the CoPc film and enhances its conductivity *via* following process:



CoPc-etched surface is expected to have higher  $\text{O}_2^-$  content as compared to CoPc-plain. It is very well reported that the



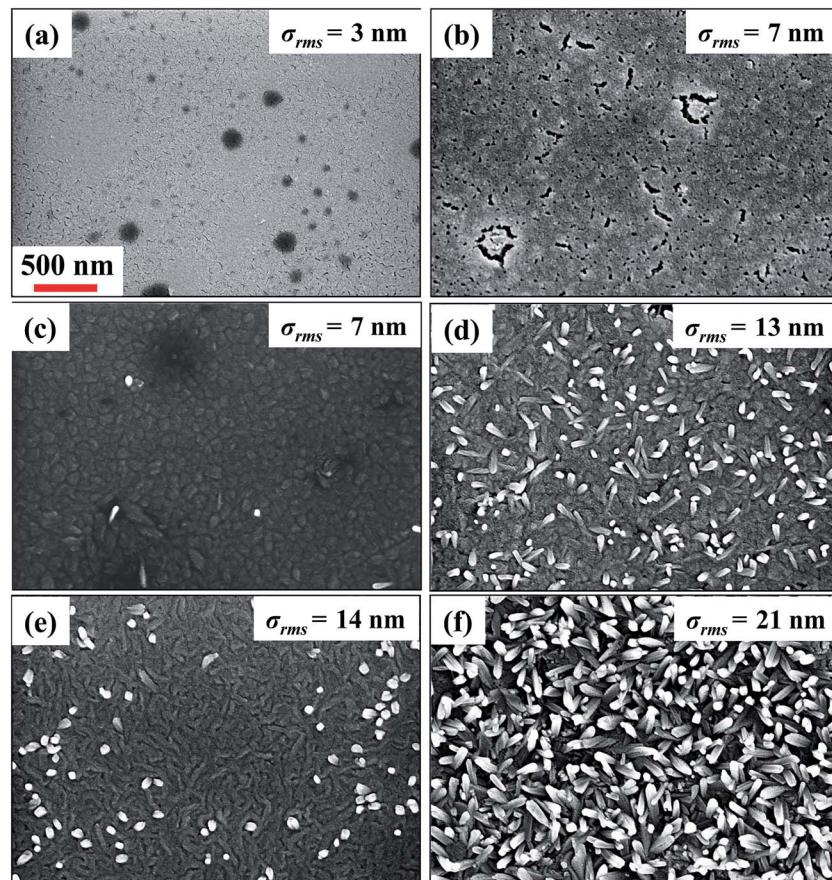


Fig. 2 (a) FESEM images of (a) plain glass (b) etched glass (c) 20 nm CoPc film grown on plain glass (d) 20 nm CoPc film grown on etched glass (e) 60 nm CoPc film grown on plain glass (f) 60 nm CoPc film grown on etched glass.

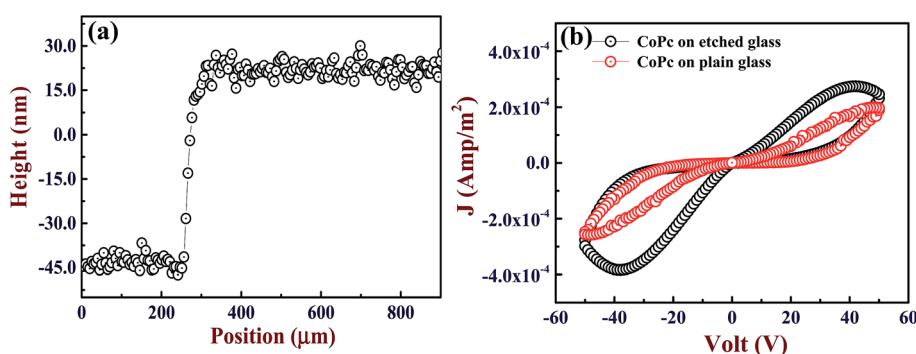


Fig. 3 (a) Thickness profile of CoPc film deposited on glass substrate. (b)  $J$ - $V$  characteristics of CoPc-plain and CoPc-etched films.

presence of  $O_2^-$  leads to the hysteresis in  $J$ - $V$  characteristics by inducing the deep traps in CoPc films.<sup>11</sup> Fig. 3(b) shows the  $J$ - $V$  characteristics of CoPc-plain and CoPc-etched. As expected, the hysteresis is present in the  $J$ - $V$  characteristics for both films, which is attributed to the existence of deep traps induced by  $O_2^-$ . In addition, the hysteresis is more pronounced in case of CoPc-etched film indicating the higher content of adsorbed oxygen due to presence of larger number of CoPc-gas interaction sites as compared to CoPc-plain film (as seen from FESEM images).

Gas sensing properties of CoPc films are attributed to the fact that exposure of these films to oxidizing gas (e.g.  $Cl_2$ ,  $NO_2$  etc.) replaces the  $O_2^-$  (eqn (i)), and promotes more holes in the CoPc film, thereby, its conductivity increases.<sup>7,9,11</sup> CoPc films show a reverse behavior if they are exposed to reducing gas ( $H_2S$ ,  $NH_3$  etc.). Both CoPc-plain and CoPc-etched films were exposed to different concentrations of  $Cl_2$  from 100 ppb to 5 ppm and the corresponding response curves are shown Fig. 4(a) and (b), respectively. The operating temperature was kept at 170 °C to maximize the sensitivity, which will be discussed later. It can be

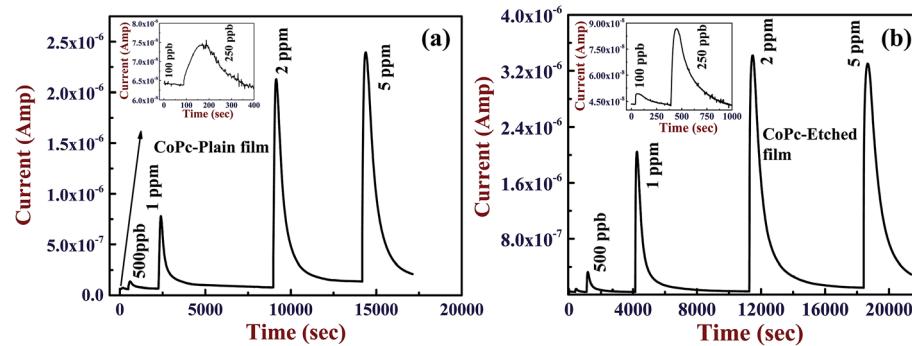


Fig. 4 Response curves for different  $\text{Cl}_2$  doses of (a) CoPc-plain film (b) CoPc-etched film. Insets represent the magnified response curve in 100–250 ppb range.

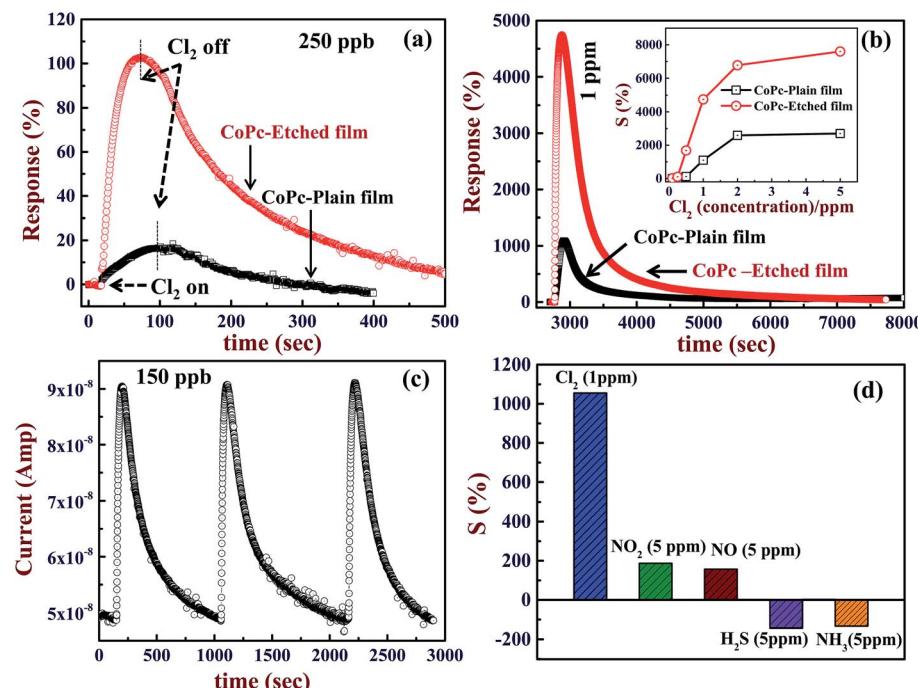


Fig. 5 Response curves (at 170 °C) for CoPc-etched and CoPc-plain films for (a) 250 ppb (b) 1 ppm (inset shows  $S$  as a function of  $\text{Cl}_2$  concentration for CoPc-plain and CoPc-etched films) (c) response curves for CoPc-etched film for repeated exposures to 150 ppb  $\text{Cl}_2$ . (d) Bar chart displaying the sensitivity for different oxidizing and reducing gases, which reveals high selectivity of CoPc-etched film to  $\text{Cl}_2$  gas.

seen that CoPc-plain film can detect  $\text{Cl}_2$  at 250 ppb level, whereas using CoPc-etched film the detection down to 100 ppb can be achieved. Furthermore, in order to compare the gas sensing properties of CoPc-plain and CoPc-etched films, typical response curves ( $R$  as a function of time) has been plotted for 250 ppb and 1 ppm exposure to  $\text{Cl}_2$  gas, are presented in Fig. 5(a) and (b). These results clearly show that that CoPc-etched film shows better response compared to CoPc-plain film. Sensitivity ( $S$ ) can be calculated by replacing  $C_t$  with  $C_s$  in eqn (1), where  $C_s$  is the conductance of CoPc film at saturation level. For 250 ppb, the values of  $S$  were found to be ~20 and 105% for CoPc-plain and CoPc-etched films, respectively. For 1 ppm, CoPc-plain film shows  $S = 1100\%$  and response time ~90 s, while CoPc-etched film exhibits 4800% and response time ~54 s. The recovery time was found to be ~1125 and

~1170 s for CoPc-plain and CoPc-etched films, respectively.  $S$  as function of  $\text{Cl}_2$  concentration is shown in inset of the Fig. 5(b). It is clear that sensitivity remains significantly higher for CoPc-etched film as compared to CoPc-plain film. These results indicate that gas sensing properties can be improved significantly by producing a suitable nanostructured surface on the substrate.  $S$  depends on the available number of gas interaction sites and charge carrier mobility. As seen from FESEM image, CoPc-etched film provides the more interaction sites as compared to CoPc-plain film. However, the mobility of the CoPc-plain film may be higher as compared to the CoPc-etched film, but comparatively large numbers of available sites present enhances the sensitivity of CoPc-etched film. It is to be noted that the nanostructured features size, *e.g.*, pores depth and size may play a very crucial role to manipulate morphology of



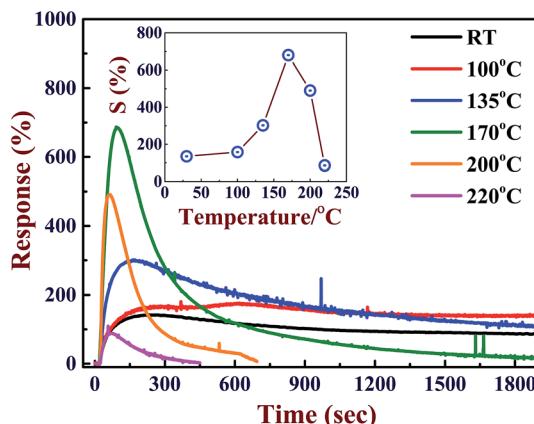


Fig. 6 Response curve of CoPc-etched film for 500 ppb Cl<sub>2</sub> exposure at different temperatures. Inset shows the value of  $S$  as function of operating temperature.

sensing material film. Therefore, choosing the appropriate thickness of CoPc and nanostructured features such as pores size, depth *etc.*, gas sensing properties can also be improved further.

The other gas sensing properties such as reproducibility, selectivity, temperature dependent sensitivity of CoPc-etched film surface were also investigated. To test the reproducibility of the response, CoPc-etched film was exposed to a known concentration of Cl<sub>2</sub> dose (150 ppb), the results obtained are shown in Fig. 5(c). It can be seen that the response remains nearly same on repeated exposure of Cl<sub>2</sub> gas, which shows that the response curves are reproducible. The sensitivity of CoPc-etched film was tested for various oxidizing and reducing gases, the results are shown in the Fig. 5(d). These results show that CoPc-etched film is highly selective to Cl<sub>2</sub> gas. The good

sensitivity of the CoPc film towards Cl<sub>2</sub> is attributed to high value of electronegativity (electron acceptor nature) and strong oxidizing nature of chlorine as compared to other gases. Cl<sub>2</sub> can replace the adsorbed oxygen very easily and get adsorbed at other free sites on the CoPc films surface. Therefore, CoPc film sensor has well selectivity towards chlorine Cl<sub>2</sub> against other gases. The gas sensing properties strongly depend on the working temperature of the sensor. To optimize the working temperature, we have measured the response curves at different operating temperatures for a concentration of 250 ppb and the corresponding results are presented in Fig. 6. It can be seen that  $S$  (shown in the inset of Fig. 6) increases with increasing the operating temperature till  $\sim 170$  °C. With further increasing the operating temperature the sensitivity decreases. Above room temperature ( $>100$  °C), the enhancement in  $S$  value may be attributed to the desorption of chemisorbed oxygen from CoPc film surface. This desorption process, thus, provides additional fresh active interaction sites for Cl<sub>2</sub> and also reduced the number of deep traps induced by oxygen. The decrease in the  $S$  value sensitivity above 170 °C may be ascribed to the fact Cl<sub>2</sub> desorbs with higher rate as compared to its adsorption at CoPc film surface. These results are in good agreement with the reported results for MPcs films.<sup>6,10,35</sup> The recovery time continuously decreases with increasing the temperature. At low temperature (up to 135 °C), CoPc films could not recover its base conductance even after 2000 seconds. These results shows that at 170 °C, the CoPc films shows maximum sensitivity with full recovery, therefore, the gas sensing properties were studied at this optimum operating temperature.

### 3.3. XPS and Kelvin probe measurements

To get more insight about the interaction sites the XPS data of CoPc-plain and CoPc-etched films were recorded. The core level

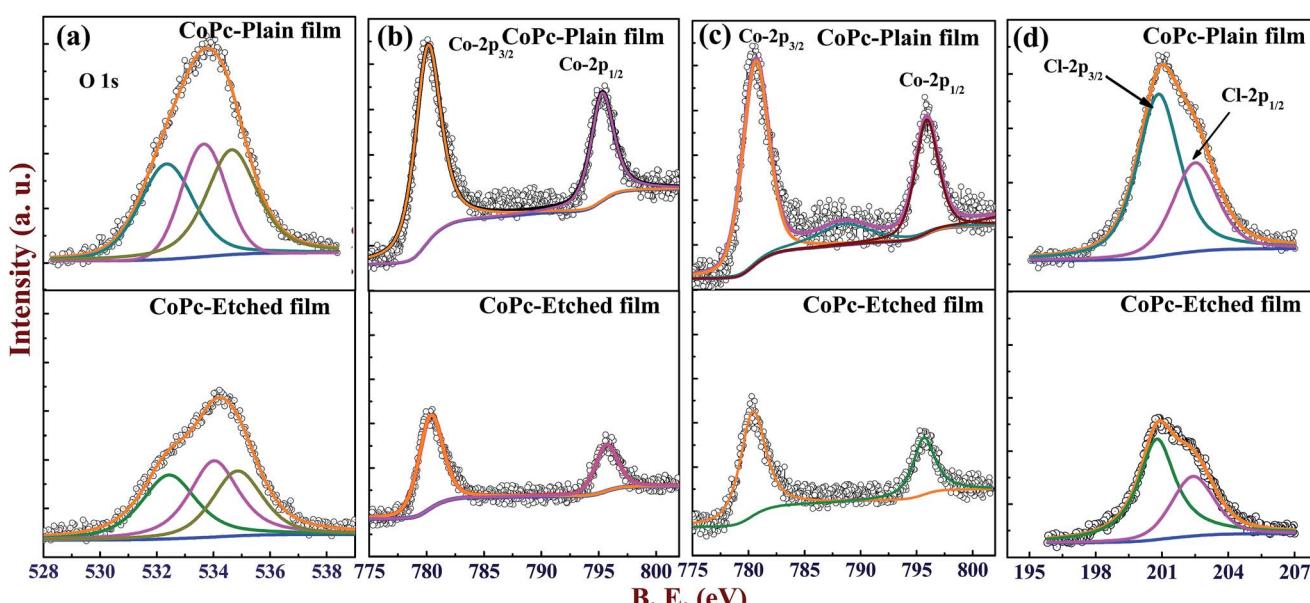


Fig. 7 XPS spectra recorded for fresh CoPc-plain and CoPc-etched film (a) O 1s and (b) Co 2p. XPS spectra recorded for CoPc-plain and CoPc-etched film after Cl<sub>2</sub> exposure (c) Co 2p and (d) Cl 2p.



O 1s and Co-2p XPS spectra for both films (before  $\text{Cl}_2$  exposure) are presented in Fig. 7(a) and (b). The core level O 1s peak CoPc is deconvoluted into three different peaks at 532.3, 533.6 and 534.6 eV, which are attributed to physisorbed oxygen, chemisorbed oxygen  $\text{O}_2^-$  and adsorbed moisture, respectively.<sup>11</sup> The Co-2p can be resolved into two peaks  $2p_{3/2}$  and  $2p_{1/2}$  at 780.3, and 795.4 eV, respectively. To compare the content of adsorbed oxygen at the CoPc-plain and CoPc-etched films surface, the physisorbed and chemisorbed oxygen composition ( $C_k$ ) relative to Co (central metal atom) was quantified using the relation:<sup>2,36</sup>

$$C_k = \frac{I_0/S_0}{\left(\frac{I_0}{S_0} + \frac{I_{\text{Co}}}{S_{\text{Co}}}\right)} \quad (2)$$

where  $I$  and  $S$  are intensity and atomic sensitivity factors, respectively, and the subscript denotes the corresponding elements. To determine the intensities of the adsorbed oxygen (physisorbed and chemisorbed) and Co peaks, the total area under the core level peaks was calculated using the least-squares fitting of Gaussian line shape.<sup>2</sup> The values of sensitivity factor were taken 0.63 and 4.50 for O 1s and Co 2p peaks, respectively.<sup>36,37</sup> The quantification of XPS results showed the total concentration of absorbed oxygen was found to be 72% (chemisorbed 33%, physisorbed 39%) and 85% (chemisorbed 41% and physisorbed 44%) for CoPc-plain and CoPc-etched film, respectively. Moreover, it is very well reported that central metal atom of MPcs plays an important role in gas sensing characteristics and it is the main attacking site for the  $\text{Cl}_2$ .<sup>7,9</sup> Therefore, in order to compare the available number of  $\text{Cl}_2$  interaction sites, both the films were exposed to 20 ppm of  $\text{Cl}_2$  concentration for a duration of 5 min at 170 °C, and after that they were cooled down to room temperature. Fig. 7(c) and (d) show XPS spectra of Co 2p and Cl 2p for CoPc-plain and CoPc-etched film after the  $\text{Cl}_2$  exposure. Cl 2p peak after the exposure was found to be in both cases, which is deconvoluted into two peaks present at 200.1 and 202.4 eV, corresponding to Cl  $2p_{3/2}$  and Cl  $2p_{1/2}$ . As the central atom in MPcs is the main reaction site for  $\text{Cl}_2$  gas molecule, therefore, the peak intensity ratio of Cl 2p and Co 2p should be higher for the more sensitive

film. The XPS quantification of  $\text{Cl}_2$  was calculated using the eqn (2) and it was found to be ~88 and ~93% for CoPc-plain and CoPc-etched, respectively. These results show that CoPc-etched film provides more interaction sites for the gas adsorption as compared to CoPc-plain, which improves its gas sensing characteristics.

Furthermore,  $\text{Cl}_2$  exposure on CoPc films affects the charge carrier concentration, and it should be reflect in work function ( $\phi$ ) measurements. To determine  $\phi$  of the sample (CoPc film), the contact potential difference ( $V_{\text{CPD}}$ ) between tip and sample was measured.  $V_{\text{CPD}}$  is developed *via* equilibrium, if an electrical contact is made between tip and the sample, which can be defined as:

$$V_{\text{CPD}} = \frac{\Delta\phi}{e}, \quad \Delta\phi = \phi_{\text{tip}} - \phi_{\text{sample}} \quad (3)$$

where,  $\phi_{\text{tip}}$  and  $\phi_{\text{sample}}$  represent the respective work function of the tip and sample.<sup>38</sup> The tip was allowed to vibrate with a frequency ( $\omega = 78.3$  Hz) just above the sample surface, which produces a periodic change in capacitance ( $dC/dt$ ). Therefore, on the application of an external voltage ( $V_{\text{ext}}$ ) to the tip, electric current flows in the circuit, which can be expressed by following equation:

$$i_{(t)} = (V_{\text{ext}} - V_{\text{CPD}}) \frac{dC}{dt} \quad (4)$$

At a unique point  $V_{\text{ext}} = V_{\text{CPD}}$ , the null condition ( $i_{(t)} = 0$ ) is obtained, and hence, the  $V_{\text{CPD}}$  can be estimated. Since,  $\phi_{\text{tip}}$  is known (from calibration),  $\phi_{\text{sample}}$  can be calculated using eqn (3). In order to compare the effect  $\text{Cl}_2$  gas, work function of both CoPc-plain and CoPc-etched films were measured before and after the  $\text{Cl}_2$  exposure. Tip was scanned in raster fashion across the CoPc film surface of area  $2 \text{ mm}^2$  and the relative variation in  $V_{\text{CPD}}$  was measured to obtain the better average result. Both films were exposed to same concentration (20 ppm) and kept in a close chamber for ~5 min. The 3D (three dimensional) images of work function for both CoPc films before and after  $\text{Cl}_2$  exposure is presented in Fig. 8(a). Before exposure, CoPc films

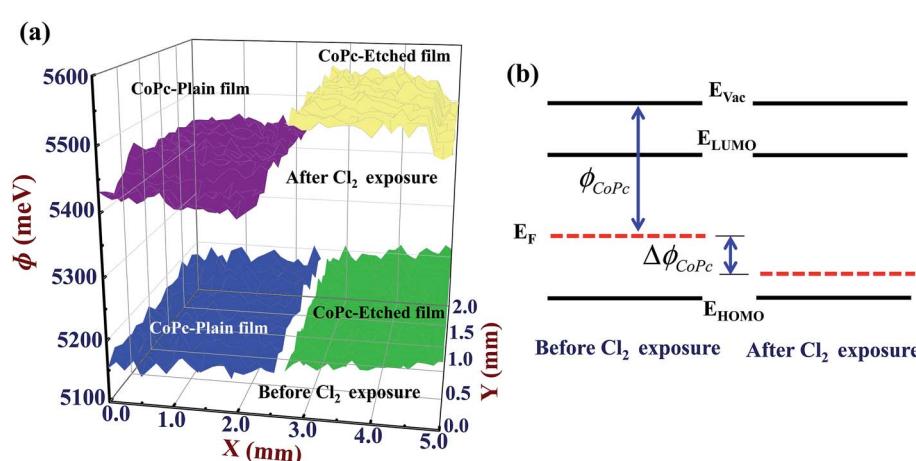


Fig. 8 (a) Work function images of CoPc-plain and CoPc-etched films before and after the  $\text{Cl}_2$  exposure. (b) The energy level diagram showing the shift in Fermi level (work function,  $\Delta\phi_{\text{CoPc}}$ ) due to the  $\text{Cl}_2$  exposure.



grown on both substrates shows nearly identical value of  $\phi$  and after the exposure it increases in both cases. This increase in the work function ( $\Delta\phi_{\text{CoPc}}$ ) is ascribed to the p-type nature of CoPc molecule and an increase in holes concentration on the exposure of  $\text{Cl}_2$  gas forces the Fermi level to move towards  $E_{\text{HOMO}}$  (highest occupied molecular orbital). An energy level diagram showing the effect of  $\text{Cl}_2$  gas exposure is presented in Fig. 8(b). After  $\text{Cl}_2$  exposure CoPc-plain and CoPc-etched show  $\Delta\phi_{\text{CoPc}} \sim 270$  meV and 345 meV, respectively (Fig. 8(a)). Relatively higher value of  $\Delta\phi_{\text{CoPc}}$  for CoPc-etched film confirms that more carriers are produced after the exposure for the same amount of  $\text{Cl}_2$  gas. Kelvin probe results further support that CoPc-etched surface has large number of gas-material interaction sites, which improves its gas sensing properties. We believe that controlling the features of porous nanostructured surface, *e.g.*, pore size, depth *etc.*, and using an appropriate substrate the sensitivity can be improved further and detection limit as low as 5 ppb can be achieved. Therefore, this study paves a new avenue for the application of surface etching process to improve the gas sensing properties of organic semiconductor thin film based sensors.

## 4. Conclusions

In conclusion, we have demonstrated the utilization of surface etching process to improve the gas sensing properties of organic semiconductor thin film based sensor. A porous nanostructured surface was fabricated *via* vapor phase etching method. FESEM results showed that CoPc nanostructures grow with faster rate on etched surface, which is attributed to the presence of nanopores on the surface and the surface of CoPc-etched film was found to be less smooth with respect to CoPc-plain film. For 60 nm, CoPc-etched film showed  $\sim 5$  times enhanced sensitivity as compared to CoPc-plain for the exposure of 250 ppb of  $\text{Cl}_2$ . The CoPc-etched film was able to detect the  $\text{Cl}_2$  gas down to 100 ppb, which is superior to CoPc-plain film. The improved gas sensing characteristics of CoPc-etched film is attributed to the presence of large number of active gas-material sites as compared to CoPc-plain film. The presence of relatively large number of gas-material interaction sites at CoPc-etched film was confirmed by charge transport, XPS and work function measurement. It is believed that fabricating the suitable nanostructure on appropriate substrate the gas sensing properties such as sensitivity, low detection limit *etc.*, can be improved further.

## Acknowledgements

The authors are thankful to the Director, CSIR-NAL for his support and encouragement.

## References

- 1 D. R. Klonne, C. E. Ulrich, M. G. Riley, T. E. Hamm Jr, K. T. Morgan and C. S. Barrow, *Fundam. Appl. Toxicol.*, 1987, **9**, 557–572.
- 2 R. Saini, A. Mahajan, R. K. Bedi, D. K. Aswal and A. K. Debnath, *Sens. Actuators, B*, 2014, **198**, 164–172.
- 3 R. B. R. Mesquita, M. L. F. O. B. Noronha, A. I. L. Pereira, A. C. F. Santos, A. F. Torres, V. Cerdá and A. O. S. S. Rangel, *Talanta*, 2007, **72**, 1186–1191.
- 4 V. D. Sickle, M. A. Wenck, A. Belflower, D. Drociuk, J. Ferdinand, F. Holguin, E. Svendsen, L. Bretous, S. Jankelevich, J. J. Gibson, P. Garbe and R. L. Moolenaar, *Am. J. Emerg. Med.*, 2009, **27**, 1–7.
- 5 D. D. Eley, *Nature*, 1948, **162**, 819.
- 6 T. Miyata, S. Kawaguchi, M. Ishii and T. Minami, *Thin Solid Films*, 2003, **425**, 255–259.
- 7 J. D. Wright, *Prog. Surf. Sci.*, 1989, **31**, 1–60.
- 8 Y. Acikbas, M. Evyapan, T. Ceyhan, R. Capan and O. Bekaroglu, *Sens. Actuators, B*, 2007, **123**, 1017–1024.
- 9 F. I. Bohrer, C. N. Colesniuc, I. K. Schuller, J. Park, A. C. Kummel, M. E. Ruidiaz and W. C. Trogler, *J. Am. Chem. Soc.*, 2009, **131**, 478–485.
- 10 D. K. Aswal and J. V. Yakhmi, *Molecular and Organic Electronics Devices*, Nova Science Publishers, New York, NY, USA, 2010.
- 11 S. Samanta, A. Kumar, A. Singh, A. K. Debnath, D. K. Aswal and S. K. Gupta, *Chem. Pap.*, 2012, **66**, 484–491.
- 12 E. Kaki, A. Altindal, B. Salih and O. Bekaroglu, *Dalton Trans.*, 2015, **44**, 8293–8299.
- 13 R. Saini, A. Mahajan, R. K. Bedi, D. K. Aswal and A. K. Debnath, *RSC Adv.*, 2014, **4**, 15945–15951.
- 14 F. I. Bohrer, C. N. Colesniuc, J. Park, I. K. Schuller, A. C. Kummel and W. C. Trogler, *J. Am. Chem. Soc.*, 2008, **130**, 3712–3713.
- 15 T. Miyata and T. Minami, *Appl. Surf. Sci.*, 2005, **244**, 563–567.
- 16 L. Tingping, S. Yunbo, L. Wenlong, L. Yang, Y. Pengliang, L. Liwei, S. Daocheng, T. Wei and W. Liquan, *J. Semicond.*, 2010, **31**, 080010–080015.
- 17 A. Kumar, A. K. Debnath, S. Samanta, A. Singh, R. Prasad, P. Veerender, S. Singh, S. Basu, D. K. Aswal and S. K. Gupta, *Sens. Actuators, B*, 2012, **171**, 423–430.
- 18 A. Kumar, N. Joshi, S. Samanta, A. Singh, A. K. Debnath, A. K. Chauhan and D. K. Aswal, *Sens. Actuators, B*, 2015, **206**, 653–662.
- 19 A. Altindal, Z. Z. Ozturk, S. Dabak and O. Bekaroglu, *Sens. Actuators, B*, 2001, **77**, 389–394.
- 20 T. Patois, J.-B. Sanchez, F. Berger, P. Fievet, V. Moutarlier, M. Bouvet, B. Lakard and O. Segut, *Talanta*, 2013, **117**, 45–54.
- 21 X. Liang, Z. Chem, H. Wu, L. Guo, C. He, B. Wang and Y. Wu, *Carbon*, 2014, **80**, 268–278.
- 22 P. Jha, M. Sharma, A. Chouksey, P. Chaturvedi, D. Kumar, G. Upadhyaya, J. S. B. S. Rawat and P. K. Chaudury, *Synth. React. Inorg. Met.-Org. Chem.*, 2014, **44**, 1551–1557.
- 23 Y. Wang, N. Hu, Z. Zhou, D. Xu, Z. Wang, Z. Yang, H. Wei, E. S.-W. Kong and Y. Zhang, *J. Mater. Chem.*, 2011, **21**, 3779–3787.
- 24 J. Tamaki, J. Niimi, S. Ogura and S. Konishi, *Sens. Actuators, B*, 2006, **117**, 353–358.
- 25 A. Chaparadza and S. B. Rananavare, *Nanotechnology*, 2008, **19**, 245501–245508.



26 J. Tamaki, C. Naruo, Y. Yamamoto and M. Matsuoka, *Sens. Actuators, B*, 2002, **83**, 190–194.

27 D. R. Patil and L. A. Patil, *Sens. Actuators, B*, 2007, **123**, 546–553.

28 D. H. Dawson and D. E. Williams, *J. Mater. Chem.*, 1996, **6**, 409–414.

29 C. V. Gopal Reddy, S. V. Manorama and V. J. Rao, *Sens. Actuators, B*, 1999, **55**, 90–95.

30 K. Garg, A. Singh, A. K. Debnath, S. K. Nayak, S. Chattopadhyay, D. K. Aswal, Y. Hayakawa, S. K. Gupta and J. V. Yakhmi, *Chem. Phys. Lett.*, 2010, **488**, 27–31.

31 P. Rao, R. V. Godbole and S. Bhagwat, *J. Magn. Magn. Mater.*, 2016, **405**, 219–224.

32 A. Joshi, D. K. Aswal, S. K. Gupta, J. V. Yakhmi and S. A. Gangal, *Appl. Phys. Lett.*, 2009, **94**, 103115.

33 A. K. Sharma, R. Saini, R. Singh, A. Mahajan, R. K. Bedi and D. K. Aswal, *AIP Conf. Proc.*, 2014, **1591**, 671–673.

34 A. Kumar, S. Siddhanta and H. C. Barshilia, *Sol. Energy*, 2016, **129**, 147–155.

35 G. Guillaud, J. Simon and J. P. Germain, *Coord. Chem. Rev.*, 1998, **467**, 178–180.

36 J. F. Moulder, W. F. Stickle, P. E. Sobol and K. D. Bomben, *Handbook of X-ray Photoelectron Spectroscopy: A Reference Book of Standard Spectra for Identification and Interpretation of XPS Data*, Physical Electronics Publisher, 1995.

37 C. D. Wagner, L. E. Davis, M. V. Zeller, J. A. Taylor, R. H. Raymond and L. H. Gale, *Surf. Interface Anal.*, 1981, **3**, 211–225.

38 Y. Rosenwaks, R. Shikler, T. Glatzel and S. Sadewasser, *Phys. Rev. B: Condens. Matter Mater. Phys.*, 2004, **70**, 085320–085326.

